

# Passivated rear contacts for high-efficiency n-type Si solar cells providing high interface passivation quality and excellent transport characteristics

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## ABSTRACT

In this work passivated rear contacts are used to replace point contact passivation schemes for high-efficiency n-type crystalline silicon solar cells. Our structure is based on an ultra-thin tunnel oxide ( $\text{SiO}_2$ ) and a phosphorus-doped silicon layer, which significantly reduce the surface recombination at the metal–semiconductor interface. The passivation and transport mechanisms of this passivated contact will be addressed within this paper. Particular consideration will be given to the tunnel oxide's impact on interface passivation and on the  $I$ – $V$  characteristics of n-type Si solar cells featuring a boron-diffused emitter. It will be shown that the tunnel oxide is a vital part of this passivated contact and that it is required to achieve excellent interface passivation for both open-circuit and maximum power point (MPP) conditions (implied open-circuit voltage  $iV_{oc} > 710$  mV and implied fill factor  $iFF > 84\%$ ). It will also become clear that the transport barrier arising from the tunnel oxide does not constrict the majority carrier flow. Thus, a low series resistance is obtained, which in conjunction with the high  $iFF$  enables  $FFs$  well above 82%. Investigations on cell levels lead to an independently confirmed conversion efficiency of 23.0% for n-type cells with a boron-diffused emitter and the herein developed passivated rear contact, in which the efficiency is not limited by the electrical properties of our passivated contacts.

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## 1. Introduction

In 1985 Yablonovich stated that an ideal solar cell should “be built in the form of a double heterostructure”, which would place the absorber between two wide-gap materials of opposite doping [1]. These semi-permeable membranes must ensure that the electrochemical energy (splitting of the quasi-Fermi levels) is completely converted into electrical energy [2]. A famous example is the HIT solar cell [3], achieving very high conversion efficiencies by making use of a heterojunction based on the hydrogenated amorphous silicon (a-Si:H), which effectively suppresses recombination at the a-Si:H and crystalline silicon (c-Si) interface as well as at the metal contacts. However, the temperature restrictions of the a-Si:H layers require a dedicated back-end processing (low-temperature deposition of transparent conductive oxide (TCO) and metallization). A temperature-stable approach is based on semi-insulating polysilicon (SIPOS), which was originally used as a passivation layer for silicon devices [4] and thence successfully implemented as an emitter in heterojunction transistors [5]. Its potential for photovoltaics was demonstrated by Yablonovich's

SIPOS solar cell, which achieved an impressively high  $V_{oc}$  of 720 mV [1]. In addition to SIPOS, the herein proposed passivated contact is closely related to the polyemitter technology, which significantly enhanced current gains of bipolar junction transistors [6]. The successful commercial application of the polysilicon emitter technology in high-speed logic circuits in the 1980s urged some researchers to apply these polysilicon contacts to solar cells with the aim to boost  $V_{oc}$  [7,8,9].

Our approach, which we have called *TOPCon* (Tunnel Oxide Passivated Contact) is based on these prior approaches and consists of an ultra-thin tunnel oxide and a phosphorus-doped silicon layer. It offers a simple processing scheme which is compatible with high-temperature processes such as diffusion.

To obtain highly efficient passivated contacts for solar cells, the following three prerequisites are to be met: (i) excellent interface passivation, (ii) efficiently doped layers to maintain the quasi-Fermi level separation in c-Si (high  $V_{oc}$ ), and (iii) an efficient majority carrier transport (high  $FFs$ ). To study the performance of our passivated contacts, their interface passivation is tested for by lifetime measurements, and prerequisites (ii) and (iii) are investigated on n-type silicon solar cells with a diffused boron-doped emitter on the front side and the newly developed passivated contacts on the rear side. Furthermore, we examine the cell's light trapping scheme with a focus on an appropriate rear metallization.

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Finally, the limitations arising from the front grid metallization are discussed and a solution is proposed to reach efficiencies well above 24%.

## 2. Experimental details and results

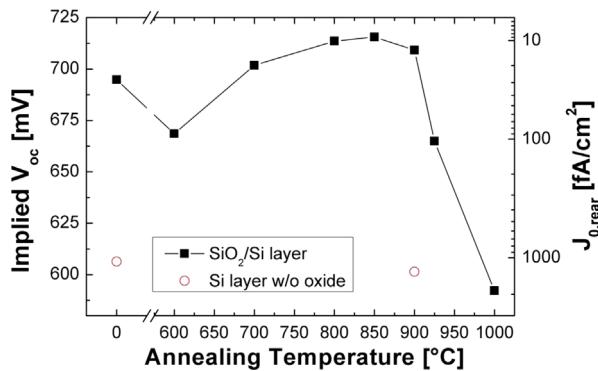
### 2.1. The interface passivation and its impact on device performance

The interface passivation quality of this passivated contact was determined on symmetrical lifetime samples by the quasi-steady-state photoconductance (QSSPC) technique [10]. Here, the implied open-circuit voltage  $iV_{oc}$  at one sun, which is calculated by

$$iV_{oc} = \frac{kT}{q} \ln \left( \frac{\Delta n(\Delta n + N_D)}{n_i^2} \right) \quad (1)$$

is used as a measure for interface passivation. Shiny-etched n-type  $1 \Omega \text{ cm}$  (100)-oriented floating zone (FZ) silicon wafers with a thickness of  $200 \mu\text{m}$  were cleaned according to the RCA cleaning procedure [11]. Then an ultra-thin wet chemical oxide layer was grown with a thickness determined to be about  $14 \text{ \AA}$  by spectroscopic ellipsometry. It should be noted, that  $20 \text{ \AA}$  is the maximum tolerable oxide thickness for the related metal-insulator–semiconductor (MIS) solar cells at which tunneling becomes inefficient and, thus, results in a lowered  $FF$  [12]. Subsequently, a  $20 \text{ nm}$  thick phosphorus-doped Si layer was deposited on both sides. Afterwards, the samples' passivation was activated in a tube furnace process with plateau temperatures in the range of  $600^\circ\text{C} < T_{\text{anneal}} < 1000^\circ\text{C}$ . Fig. 1 plots the  $iV_{oc}$  at 1 sun over  $T_{\text{anneal}}$ . It can be seen that a good passivation can be obtained already after deposition of the Si layer. Depending on the annealing conditions, the good initial passivation can be further boosted to very high implied voltages ( $iV_{oc}$  well above  $710 \text{ mV}$ ). To relate our achievements with results from prior art, the corresponding  $J_{0,\text{rear}}$  values of lifetime samples with  $iV_{oc} > 710 \text{ mV}$  were determined using the method proposed by Kane and Swanson [13].  $J_{0,\text{rear}}$  values in the range of  $9\text{--}13 \text{ fA/cm}^2$  were measured and show that our passivated contacts perform equally well as SIPOS ( $10 \text{ fA/cm}^2$ ) [1] and as polyemitters with deliberately grown interfacial oxide ( $20 \text{ fA/cm}^2$ ) [9].

For  $T_{\text{anneal}} > 900^\circ\text{C}$ , a strong decrease in the interface passivation is observed. This can be explained with the local disruption of the  $\text{SiO}_2$  tunnel junction in oxygen-free ambient according to the reaction  $\text{SiO}_2(\text{s}) + \text{Si}(\text{s}) \rightarrow 2 \text{SiO}(\text{g})$ , where s and g denote the solid and gaseous phase, respectively. This balling-up of oxide was also observed for polyemitter devices with deliberately grown



**Fig. 1.** The diagram depicts the implied  $V_{oc}$  of the TOPCon's interface passivation as a function of the plateau temperature  $T_{\text{anneal}}$  of the furnace anneal. The samples without tunnel oxide (red circles) clearly underline the importance of the tunnel oxide layer for surface passivation. Additionally, the right y-axis depicts the corresponding  $J_{0,\text{rear}}$  values calculated according to Eq. (3). (For interpretation of the references to color in this figure caption, the reader is referred to the web version of this article.)

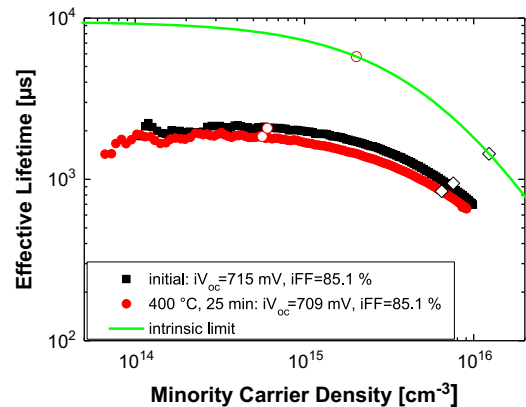
interfacial oxides [14] and inevitably leaves behind large areas of unpassivated silicon in direct contact with the Si layer. Notably, the tunnel oxide is crucial to obtain very high passivation quality, since lifetime samples solely passivated by an as-deposited Si layer or an annealed Si layer (red circles in Fig. 1) yield very low  $iV_{oc}$  values. A similar behavior for polyemitter contacts was observed by Kwark et al. [9].

Apart from a high  $V_{oc}$ , passivated contacts must also provide low interface recombination at MPP conditions to allow for high  $FFs$  [15]. Provided that the device would only be limited by Auger recombination, the upper limit for the fill factor  $FF_0$  [16] is 89%. In Fig. 2 an injection-dependent effective minority carrier lifetime-curve  $\tau_{\text{eff}}(\Delta n)$  is shown and the implied solar cell parameters  $iV_{oc}$  and  $iV_{\text{MPP}}$  are marked, respectively. The implied  $iV_{\text{MPP}}$  is obtained from the implied  $J$ - $V$  curve calculated from the  $\tau_{\text{eff}}(\Delta n)$  curve and can be understood as a similar measure for device performance as the  $PFF$  is for SunsVoc measurements [17]. While Auger recombination dominates at open-circuit (OC) conditions, the device does not operate close to the Auger limit at  $iV_{\text{MPP}}$ . However, a high implied fill factor  $iFF$  of about 85% is still obtained. To approach the ideal  $FF_0$  of 89%, the interface passivation at MPP conditions must be even further enhanced to shift  $iV_{\text{MPP}}$  into the Auger recombination regime. The reduced passivation quality of the unpassivated lifetime samples (without tunnel oxide) leads thus not only to a lower  $iV_{oc}$  but also to a reduced  $iFF$  of about 83%.

While the passivated contact easily withstands typical diffusion temperatures, its interface passivation after the activation process should be stable at temperatures in the range of  $400^\circ\text{C}$  to provide more opportunities for back-end processing. A typical process such as contact sintering and silicidation was simulated quite realistically by hotplate annealing of the symmetrical lifetime samples at  $400^\circ\text{C}$ . In Fig. 2 it can be observed that the passivation quality and  $iV_{oc}$  values above  $700 \text{ mV}$  can be maintained during the applied annealing conditions. Thus, the passivated contact imposes fewer restrictions on back-end processing compared to classical a-Si:H based passivation schemes. A detailed study on the thermal stability, taking into account various TCO capping layers, will be performed in the future.

### 2.2. High-efficiency solar cells and transport characteristics

To investigate whether this passivated contact would be an efficient majority carrier contact, it was implemented at the rear side of n-type silicon solar cells with a diffused boron-doped



**Fig. 2.** Measured injection dependent effective minority carrier lifetime for a sample symmetrically passivated by the TOPCon structure after thermal treatment at  $800^\circ\text{C}$  and subsequent hotplate annealing at  $400^\circ\text{C}$  for 25 min, respectively. The figure also depicts the open-circuit (1 sun, open diamonds) and MPP conditions (open circles) as well as the intrinsic limit of the absorber calculated according to [24].

emitter ( $140 \Omega/\text{sq}$ ) at the front side (see Fig. 3). The cells ( $2 \times 2 \text{ cm}^2$ ) were processed on n-type  $1 \Omega \text{ cm}$  FZ silicon wafers. They feature a front surface with random pyramids and a passivated boron-diffused emitter. The  $20 \mu\text{m}$  wide fingers were realized by thermal evaporation of a Ti/Pd/Ag seed layer and subsequent electroplating of Ag. The TOPCon structure at the rear surface was deposited and activated following emitter diffusion and drive-in anneal.

Table 1 lists the corresponding solar cell results for cells with passivated rear contacts and for those labeled “unpassivated” rear contacts, which do not employ the passivating tunnel oxide.

Most importantly, the tunnel oxide layer needed for passivation does not hinder majority charge carrier transport across its barrier and thus allows for excellent FFs of above 82%. From SunsVoc measurements [18] we obtained a PFF of 84.5%, which is the result of low device recombination at MPP conditions. The small difference between PFF and FF translates into a very low series resistance of  $R_{S,\text{SunsVoc}} = 0.41 \Omega \text{ cm}^2$ , which is calculated according to [19]

$$R_{S,\text{SunsVoc}} = (PFF - FF) \frac{V_{oc} J_{sc}}{J_{mp}^2} \quad (2)$$

Additionally, the light  $I$ - $V$  method, which compares the light  $I$ - $V$  curve with the  $J_{sc}$ -shifted dark  $I$ - $V$  curve, was utilized to confirm the result obtained from the SunsVoc-method. Here,  $R_{S,\text{light}} = 0.37 \Omega \text{ cm}^2$  corroborates above calculation. The individual contributions to  $R_s$  can be easily identified by TLM measurements of the specific contact resistances in conjunction with simple spread-sheet calculations according to Goetzberger [20]. Due to a small pitch ( $800 \mu\text{m}$ ) and silver's very low resistivity ( $\rho_{\text{met}} = 1.6 \mu\Omega \text{ cm}$ ), the lateral transport in the emitter and series resistance of the fingers make minor contributions ( $R_{\text{emitter}} = 0.08 \Omega \text{ cm}^2$  and  $R_{\text{finger}} = 0.07 \Omega \text{ cm}^2$ ). On

the other hand, the grid's specific contact resistance  $\rho_c$  is determined to be as high as  $9 \text{ m}\Omega \text{ cm}^2$ , which translates into an upper value for the contact resistance at the diffused emitter of about  $0.35 \Omega \text{ cm}^2$ . While the passivated contact's specific contact resistance takes a value of about  $10 \text{ m}\Omega \text{ cm}^2$ , its contribution to  $R_s$  can be neglected since the rear is fully metallized. Thus, the relatively small loss in FF due to series resistance can be solely attributed to the solar cell's front side.

While solar cells with point contact rear side passivation schemes (e.g. PERL) trade off  $V_{oc}$  for FF [21], the proposed passivated contact decouples the absorber's passivation from the metallization. Thus, the latter allows for a one-dimensional carrier transport in the base, thereby leading to a FF which is more than 1% absolute higher than the FF of a PERL solar cell featuring a similar front side [22]. Furthermore, the cells without oxide layer stress the importance of a low device recombination at MPP conditions. While the FF is absolutely 1% lower compared to the cells with the passivated rear contacts, the series resistance remains the same ( $R_{S,\text{SunsVoc}} = 0.40 \Omega \text{ cm}^2$ ). Thus, the loss in FF can be ascribed to a lower iFF (as observed in Section 2.1) which reduces the PFF to 83.6%.

In addition to the high FF, a good  $V_{oc}$  as high as 691 mV can be obtained with this solar cell structure. In order to determine the weight of front and rear recombination, the  $J_0$  value is calculated by

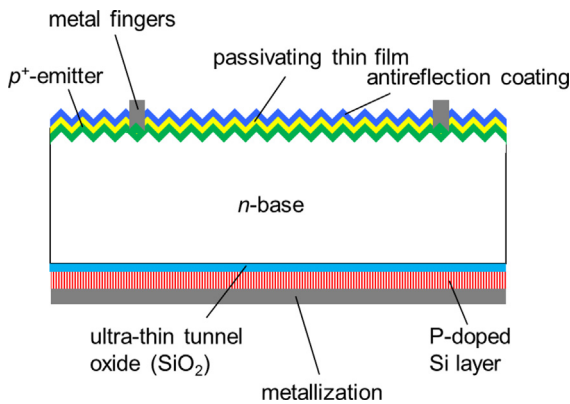
$$J_0 = J_{0,e} + J_{0,b} = J_{0,e} + J_{0,\text{rear}} + qn_i^2 \frac{W}{N_D \tau_p}, \quad (3)$$

where  $n_i = 8.3 \times 10^9 \text{ cm}^{-3}$  [23] and  $t_p = 3.4 \text{ ms}$  is the Auger lifetime after [24]. Although this analysis is only valid for low level injection conditions and, thus, prone to error in the case of n-type cells with  $N_D = 5 \times 10^{15} \text{ cm}^{-3}$ , it is nevertheless a useful approximation unveiling the limiting factors. While the emitter is well passivated ( $J_{0e,\text{pass}} = 11 \text{ fA/cm}^2$ ), the unpassivated metal-semiconductor front contacts are the dominant source for recombination ( $J_{0e,\text{contact}} = 1800 \text{ fA/cm}^2$ ) and constitute an intrinsic loss mechanism of homojunction solar cells. With a metallized area fraction of about 3%, the total  $J_{0e}$  of  $64 \text{ fA/cm}^2$  results in an upper limit ( $J_{0b} = 0$ ) for the cell's  $V_{oc}$  of about 700 mV. Taking into account the very low contribution of the rear contact ( $J_{0,\text{rear}} = 9 \text{ fA/cm}^2$ ) and the base (total  $J_{0b} = 22 \text{ fA/cm}^2$ ) to the cell's recombination current yields a  $V_{oc}$  of about 690 mV. Thus, the  $V_{oc}$  gap of  $> 20 \text{ mV}$  between the solar cells and the lifetime samples can be mainly attributed to the recombination at the unpassivated metal-semiconductor front contacts.

As expected, the  $V_{oc}$  of the solar cells with an unpassivated contact (without tunnel oxide layer) is drastically decreased to 638 mV due to a high  $J_{0b} = 593 \text{ fA/cm}^2$ .

### 2.3. Light management at the rear side

In addition to a high  $V_{oc}$  and FF, a high-efficiency solar cell must have a transparent front side and an efficient light-trapping scheme, thus enhancing the optical path length within the absorber by several orders of magnitude. This is well done for



**Fig. 3.** Schematic of the solar cell structure with the passivated rear contact. The solar cells feature a diffused boron-doped emitter at the front side which is passivated by atomic layer deposited (ALD) aluminum oxide  $\text{Al}_2\text{O}_3$  and a plasma-enhanced chemical vapor deposited (PECVD) silicon nitride  $\text{SiN}_x$ .

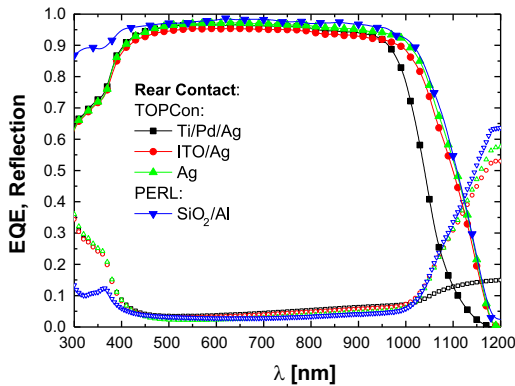
**Table 1**

$I$ - $V$  results of n-type solar cells featuring either a passivated rear contact or an unpassivated rear contact (w/o tunnel oxide layer) at the rear.

	$V_{oc}$ (mV)	$J_{sc}$ ( $\text{mA/cm}^2$ )	FF (%)	PFF (%)	$\eta$ (%)
<b>Passivated rear contact</b>					
Average (7 cells)	$690.4 \pm 0.9$	$38.4 \pm 0.1$	$81.9 \pm 0.2$	$84.5 \pm 0.0$	$21.7 \pm 0.1^a$
Best	<b>690.8</b>	<b>38.4</b>	<b>82.1</b>	<b>84.5</b>	<b>21.81<sup>a</sup></b>
<b>Unpassivated rear contact</b>					
Average (7 cells)	$637.7 \pm 0.5$	$37.7 \pm 0.1$	$81.2 \pm 0.1$	$83.6 \pm 0.0$	$19.5 \pm 0.0$
Best	<b>638.3</b>	<b>37.8</b>	<b>81.1</b>	<b>83.6</b>	<b>19.6</b>

<sup>a</sup> Solar cell results are independently confirmed by Fraunhofer ISE Callab.

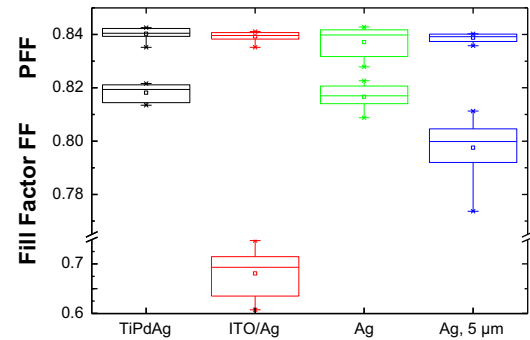
PERL solar cells, which feature a thick dielectric layer with a low index of refraction [22], ensuring that most light is totally reflected and not absorbed by the rear metallization. However, the application of any insulating dielectric layer would contradict the idea of our TOPCon structure and, thus, it would lose the inherent FF advantage of the one-dimensional junction design. Thus, the requirement for the rear contact in terms of internal reflection is quite high. The importance of a suitable rear side metallization is highlighted by our reference cell, where the rear is contacted by a stack of Ti/Pd/Ag. Here, the average short-circuit current  $J_{sc}$  is only 38.4 mA/cm<sup>2</sup>, approximately 2–3 mA/cm<sup>2</sup> lower than that of a comparable PERL solar cell. The poor internal reflection of light at the rear side, as can be seen from the low reflectance in the range of 1000 nm <  $\lambda$  < 1200 nm (see Fig. 4), can be explained by the absorption of evanescent waves at the metal surface. Thus, comparing the integrated EQE from 1000 nm to 1200 nm shows that there is a room for more than 2.8 mA/cm<sup>2</sup>. To improve the internal reflection, a conductive back reflector (i.e. TCO) [25] with negligible absorption and/or a suitable metallization (i.e. Ag) [26] has to be implemented. Bivour et al. demonstrated that for a-Si:H (p) rear-emitter solar cells [26] Ag significantly increases the rear side reflection of cells with a textured front and planar rear. While this holds true for shiny-etched or polished surfaces, this is not the case for textured (or rough) rear surfaces [27], which are more



**Fig. 4.** External quantum efficiency (lines and closed symbols) as well as the reflection (open symbols) of solar cells with different rear metallization schemes is plotted over wavelength. Titanium is a very loose metal and offers very weak reflection above 1000 nm. On the contrary, the stack of ITO/Ag reflects almost as much light as the Ag single layer. The best light management is obtained with our PERL cell (open symbols) [20] featuring a 100 nm SiO<sub>2</sub>/Al mirror. Note, the cell's reflection in the wavelength range below 400 nm and between 600 and 1000 nm is slightly lower due to the use of inverted pyramids and a double antireflection coating.

common in heterojunction solar cells. Here, the Ag back reflector needs to be buffered from the Si layer by a TCO which does not absorb the evanescent waves. Recently, Holman et al. showed that the optimum thickness of the rear ITO layer is in the range of 150–200 nm, at which the evanescent waves can completely decay within the ITO layer and not get absorbed at the ITO/Ag interface [25]. To this end, similar solar cells were processed in which the Ti/Pd/Ag metal stack at the rear is replaced by a stack of a lowly doped 200 nm ITO/1 μm Ag and a single layer of 1 μm Ag, respectively.

The corresponding solar cell results are given in Table 2. The rear side reflection shown in Fig. 4 is significantly increased by applying the ITO/Ag stack and Ag single layer respectively. The light management of our passivated contacts in conjunction with the Ag single layer in particular is almost as good as the PERL reference and, thus, a very high  $J_{sc}$  of up to 40.1 mA/cm<sup>2</sup> is achieved. While both rear metallization schemes improve  $J_{sc}$ , only the cells with an Ag single layer achieve FFs above 82% (see Fig. 5). Contrary to this, the cells with the ITO/Ag stack suffer from a pronounced series resistance, thereby decreasing the FF below 75%. To further characterize the FF losses at the rear contact, which were also observed on a-Si:H(p) rear-emitter solar cells by Bivour et al. [28], TLM measurements of the contact resistances of Si layer/ITO and ITO/Ag are to be carried out in the future. In addition, the tiny decrease in  $V_{oc}$  can be ascribed to sputter damage of the interface passivation, which was also observed on lifetime samples (results not shown here).



**Fig. 5.** Pseudo-fill factor and fill factor are plotted for different rear metallization schemes (Ti/Pd/Ag, ITO/Ag, and Ag). Additionally, PFF and FF of the cells with Ag rear metallization and 5 μm (instead of 20 μm) contact opening on the front side (Ag, 5 μm) are given. The data reveals that the ITO/Ag stack introduces a pronounced series resistance effect while the Ag single makes good contact to the doped Si layer as well as the reference Ti/Pd/Ag does. The drop in FF for the solar cells with the smaller contact opening (Ag, 5 μm) on the front can be attributed to an increased contact resistance.

**Table 2**

*I*–*V* results of n-type solar cells featuring passivated rear contacts featuring either a stack of lowly doped ITO/Ag or a Ag single layer. In addition, the metallized area fraction of the front grid electrodes was varied.

	$V_{oc}$ (mV)	$J_{sc}$ (mA/cm <sup>2</sup> )	FF (%)	PFF (%)	$\eta$ (%)
ITO/Ag at the rear, 20 μm contact opening					
Average (7 cells)	683.2 ± 1.8	39.3 ± 0.1	68.1 ± 4.4	83.9 ± 0.2	18.3 ± 1.1
Best	<b>681.8</b>	<b>39.1</b>	<b>74.7</b>	<b>83.5</b>	<b>19.9</b>
Ag at the rear, 20 μm contact opening					
Average (7 cells)	684.8 ± 2.4	39.5 ± 0.2	81.7 ± 0.4	83.7 ± 0.5	22.1 ± 0.3
Best	<b>687.4</b>	<b>39.6</b>	<b>82.3</b>	<b>84.1</b>	<b>22.4</b>
Ag at the rear, 5 μm contact opening					
Average (7 cells)	696.0 ± 1.3	40.6 ± 0.1	79.8 ± 1.1	83.9 ± 0.2	22.5 ± 0.4 <sup>a</sup>
Best	<b>698.1</b>	<b>40.6</b>	<b>81.1</b>	<b>84</b>	<b>23.02<sup>a</sup></b>

<sup>a</sup> Solar cell results are independently confirmed by Fraunhofer ISE Callab.

## 2.4. Improving $V_{oc}$

As shown above, the  $V_{oc}$  of the reference cells is limited by the recombination at the metal–semiconductor front contacts. To further improve the  $V_{oc}$ , solar cells with contact openings measuring at just 5  $\mu\text{m}$  in width, albeit with the same finger geometry ( $20 \times 10 \mu\text{m}$ ) were processed. Thus, the nominal metallized area fraction is reduced from a  $A_{\text{metal}}$  of approximately 3% to roughly 1.1%. Owing to a smaller  $J_{oe}$  of approximately 30  $\text{fA}/\text{cm}^2$ , the  $V_{oc}$  is expected to be slightly above 700 mV. Compared to the calibrated cells with a 3% metallized area fraction (see Table 1), the  $V_{oc}$  is indeed 7 mV larger and comes close to the estimated value. However, the increased  $V_{oc}$  comes at the cost of  $FF$  which is on average 1.9% lower than the  $FF$  of the cells with 20  $\mu\text{m}$  contact opening (see Fig. 5 and Table 2). This loss in  $FF$  can be solely attributed to an even increased contribution of the contact resistance beneath the metal fingers to the cell's aggregate series resistance ( $R_{S,\text{Suns}V_{oc}} = 0.79 \Omega \text{ cm}^2$ ). Unless the contact resistance of the grid fingers is negligible ( $\rho_c < 10 \mu\Omega \text{ cm}^2$ ), there is always a trade-off between  $V_{oc}$  and  $FF$ . And more importantly, even a tiny metallized area fraction of about 1.1% reduces the upper limit for the  $V_{oc}$  by more than 10 mV ( $A_{\text{metal}} = 0\%$ :  $V_{oc} \approx 714 \text{ mV}$ ,  $J_{oe} = 11 \text{ fA}/\text{cm}^2$ ,  $J_{ob} = 22 \text{ fA}/\text{cm}^2$ ). Therefore, to further increase the  $V_{oc}$  while maintaining high  $FF$ s  $> 82\%$ , a passivated contact with opposite doping for the boron-doped emitter is to be developed.

## 3. Summary

A thermally stable passivated contact for the rear side base contact of n-type silicon solar cells has been presented. It has been shown that our *TOPCon* structure based on a tunnel oxide and phosphorus doped Si layer passivates the surface effectively for both MPP and OC conditions and enables the extraction of  $V_{oc}$ s higher than 710 mV. The related  $J_{ob}$  value is as low as 22  $\text{fA}/\text{cm}^2$ . The solar cells with the *TOPCon* structure have shown excellent performance regarding  $V_{oc}$  and  $FF$ . Contrary to point contact rear side passivation schemes like PERL, its one-dimensional design facilitates processing (no structuring and alignment) and enables high  $FF$ s above 82% while maintaining a high  $V_{oc}$ . The best cell has an independently confirmed efficiency of 23.0%. It has also been demonstrated that the efficiency is limited by the recombination at the unpassivated metal–semiconductor front contacts and that a viable solution would be a passivated contact for the boron-doped homojunction emitter. Such technology should further increase the efficiency of this solar cell concept well above 24%.

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